

SID

Factory: Rot am See

Article:

524

ML6

Provided:

Kracht, Enrico

Customer:

Date:

10.08.2015



Processtechnology: B: undefiniert

Material Text	Mat. Nr.	µm	Stackup	Process overview
A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	1
A-RS-FR4-Prepreg-106-TG150-HF	50200640	85		2
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		3
C-RS-FR4-ML-0.10mm-070+070-TG150-HF	50200773	70	L2	4
		100		
		70	L3	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	160		5
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		6
C-RS-FR4-ML-0.10mm-070+070-TG150-HF	50200773	70	L4	7
		100		
		70	L5	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	85		8
A-RS-FR4-Prepreg-106-TG150-HF	50200640	0		9
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	10

B00

Thickness after Pressing

B00:

890 µm

Tol+:

100 µm

Tol-:

100 µm

Dmax:

990 µm

Dmin:

790 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

1000 µm

Tol+:

100 µm

Tol-:

100 µm

Dmax:

1100 µm

Dmin:

900 µm

Measuring point: (05) über LM und galv.Cu; beidseitig

nominal:

846 µm

Version 1.2.14.15

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